

Full Silicon Tracker

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(on behalf of full silicon tracker group)

CepC CDR International Review

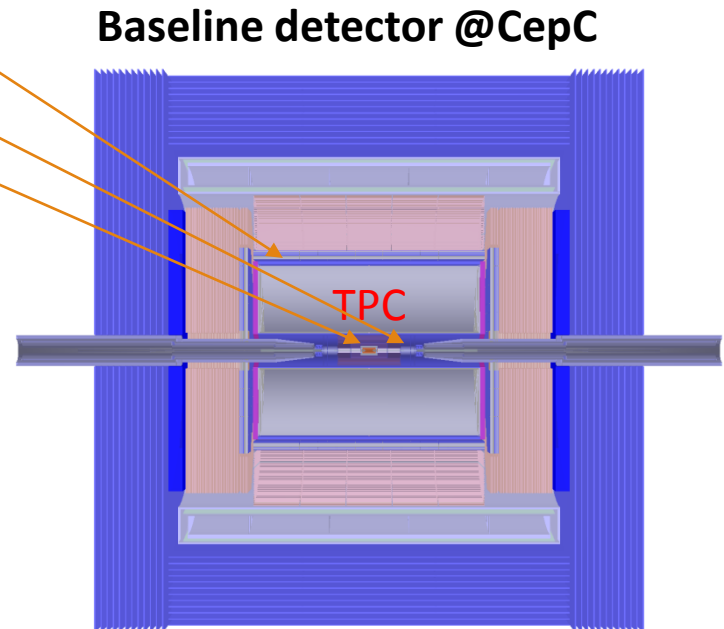
Beijing, 2018

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Introduction

- **Partial silicon tracker (VXD, FTD, SIT/SET) + TPC** is designed as the tracker in the baseline detector for **CepC**. But other one or more tracker is still needed as the design for the potential second IP or as a backup tracker for the preferred tracker.
 - **CepC** silicon study group have studied their technology and ongoing
- **ILD, FCC-ee, CLIC, HL-LHC** have proposed the full silicon tracker as their main tracker.



- The study on full silicon tracker: technology, layout design and performance.
 - The technology can benefit from the partial silicon tracker study.
 - The full silicon tracker designs in other colliders can be referenced.

Technology

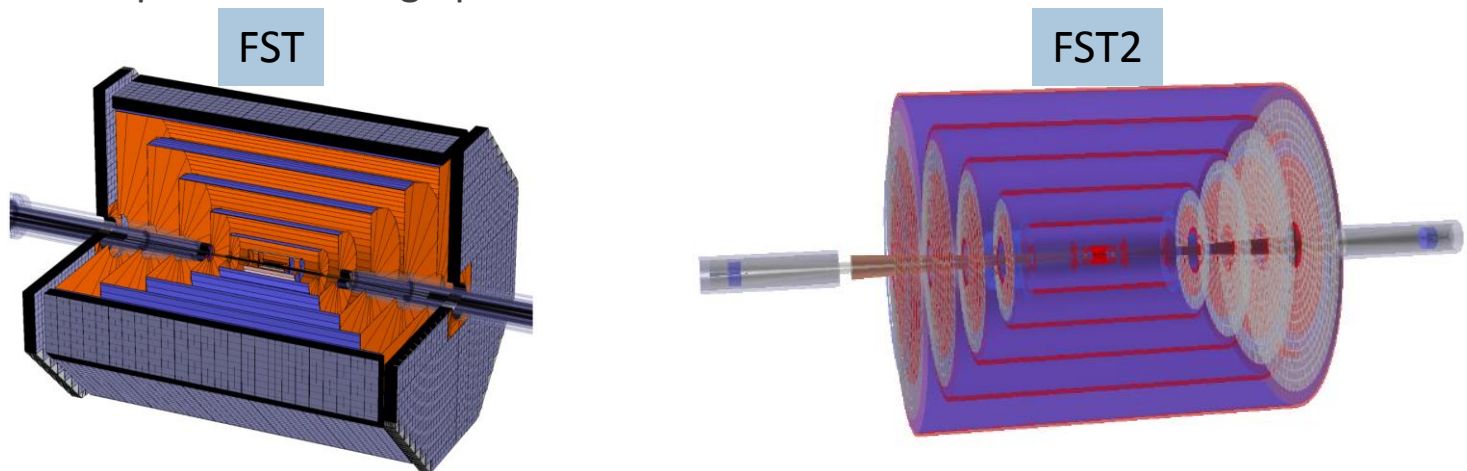
- Planary layers cover solid angle as much as possible.
 - support layer + silicon layer:
 - ✓ double side
 - ✓ single side
 - other support
 - electronics

- Silicon sensor technology (**CMOS**) is same as the **VXD**, **FTD**, **SIT/SET** in the baseline detector.
 - VXD:
 - ✓ Toward **16 μm** pitch (**2.8 μm** single-point resolution)
 - SIT/SET and FTD_STRIP:
 - ✓ **50μm** pitch
 - ✓ **<200μm** thickness
 - FTD_PIXEL:
 - ✓ **50μm**

- Electronics
 - Same as the baseline, not yet considered in simulation

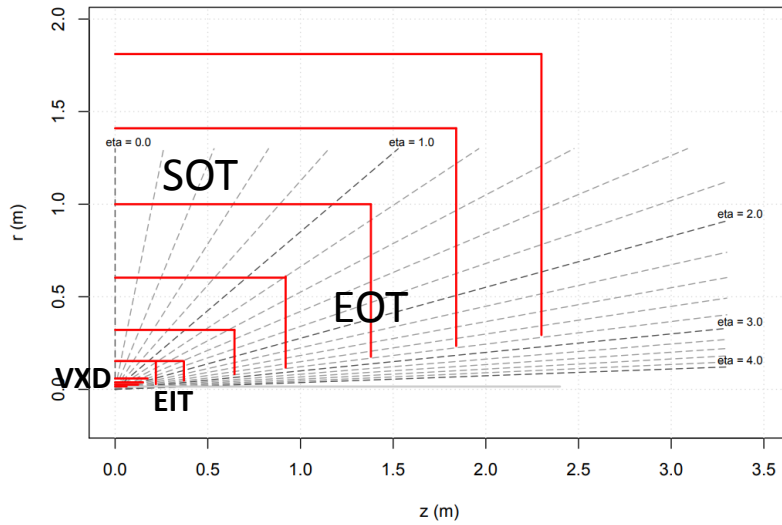
Full Silicon Tracker (**FST**) Concept designs

- Replace **TPC** with silicon tracker and re-design silicon parts in the baseline, same beam pipe and calorimeters
 - 3.0 Tesla
 - 14.5 mm outer radius for Be beam pipe
 - Maximum 1.83 m outer radius and 4.6 m length at Z direction
- Two options
 - **FST**: expand extra **SIT** layers and **FTD** disks to fill the tracker space, and rename the parts
 - **FST2**: expanding the **SID** design to full tracking volume
- Double strip layer for **FST** and single strip layer for **FST2**
 - **FST**: more expensive and high performance

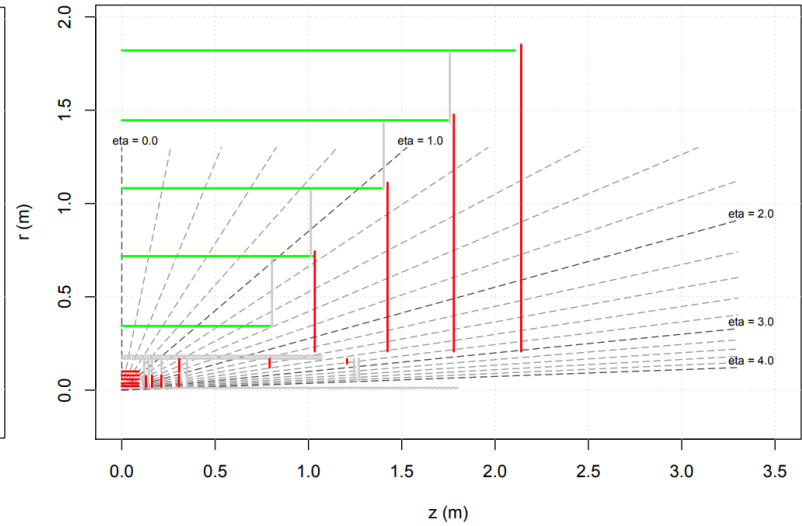


Layouts

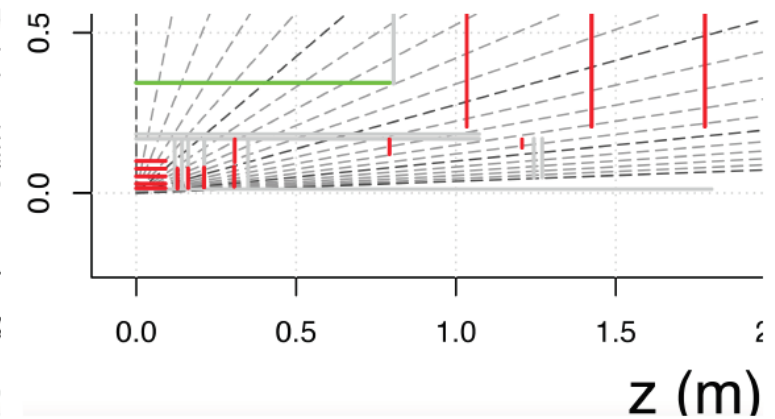
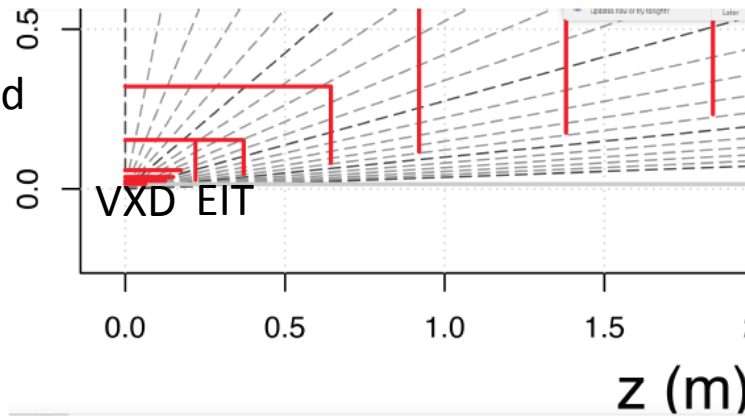
FST geometry



FST2 geometry

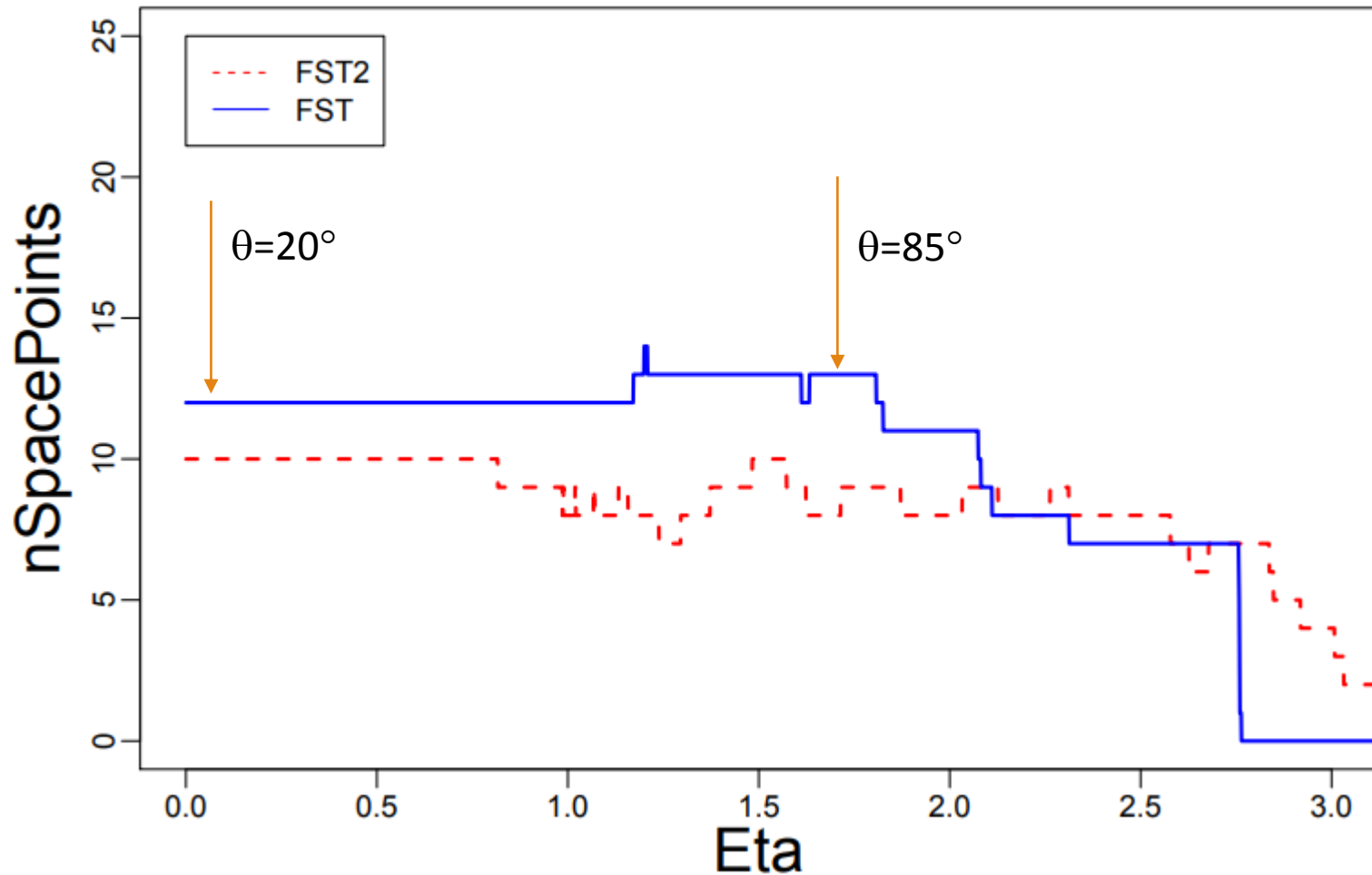


Zoomed



Space point

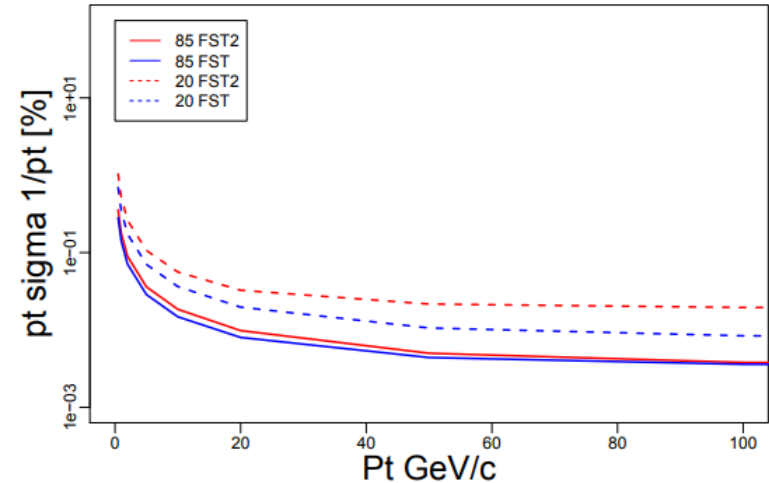
nSpacePoints vs. eta for test layouts



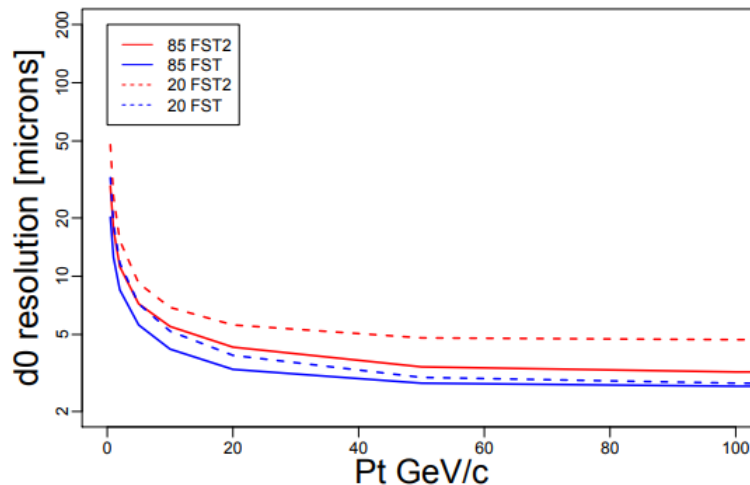
Fast simulation

- Resolutions for tracks with $\theta=85^\circ$ and 20° , represent for endcap and barrel
 - **FST** has better resolutions, benefit from more space points
 - Detail **FST2** study
<http://atlaswww.hep.anl.gov/hepsim/detectorinfo.php?id=sidcc3>

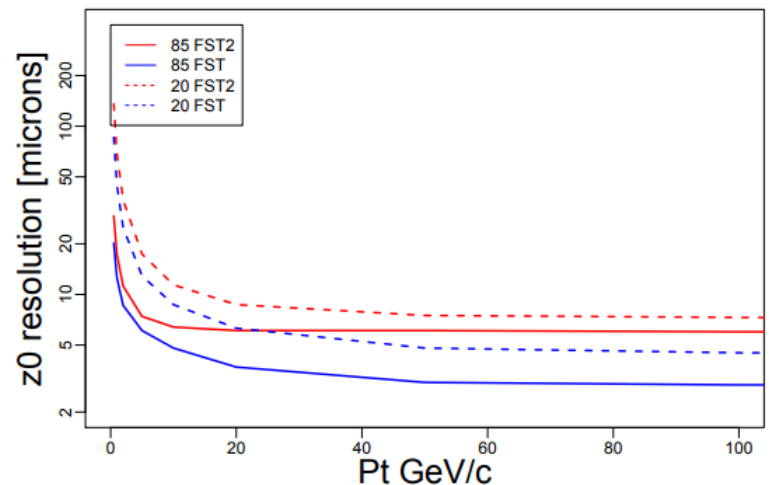
pT resolution vs. pt for test layout



d0 resolution vs. pt for test layout



z0 resolution vs. pt for test layout



Layer Materials of FST

■ Mechanical properties have not been studied in detail

VXD (pixel)	silicon	kapton	aluminium	foam	Total support
Thickness(mm)	0.05	0.05	0.01	0.94	1

SOT (strip)	silicon	peek	Carbon fiber	Rohacell 50D	epoxy	Carbon fiber	Total support
Thickness(mm)	0.15+0.0024	0.1	0.08	0.9	0.08	0.08	1.2424

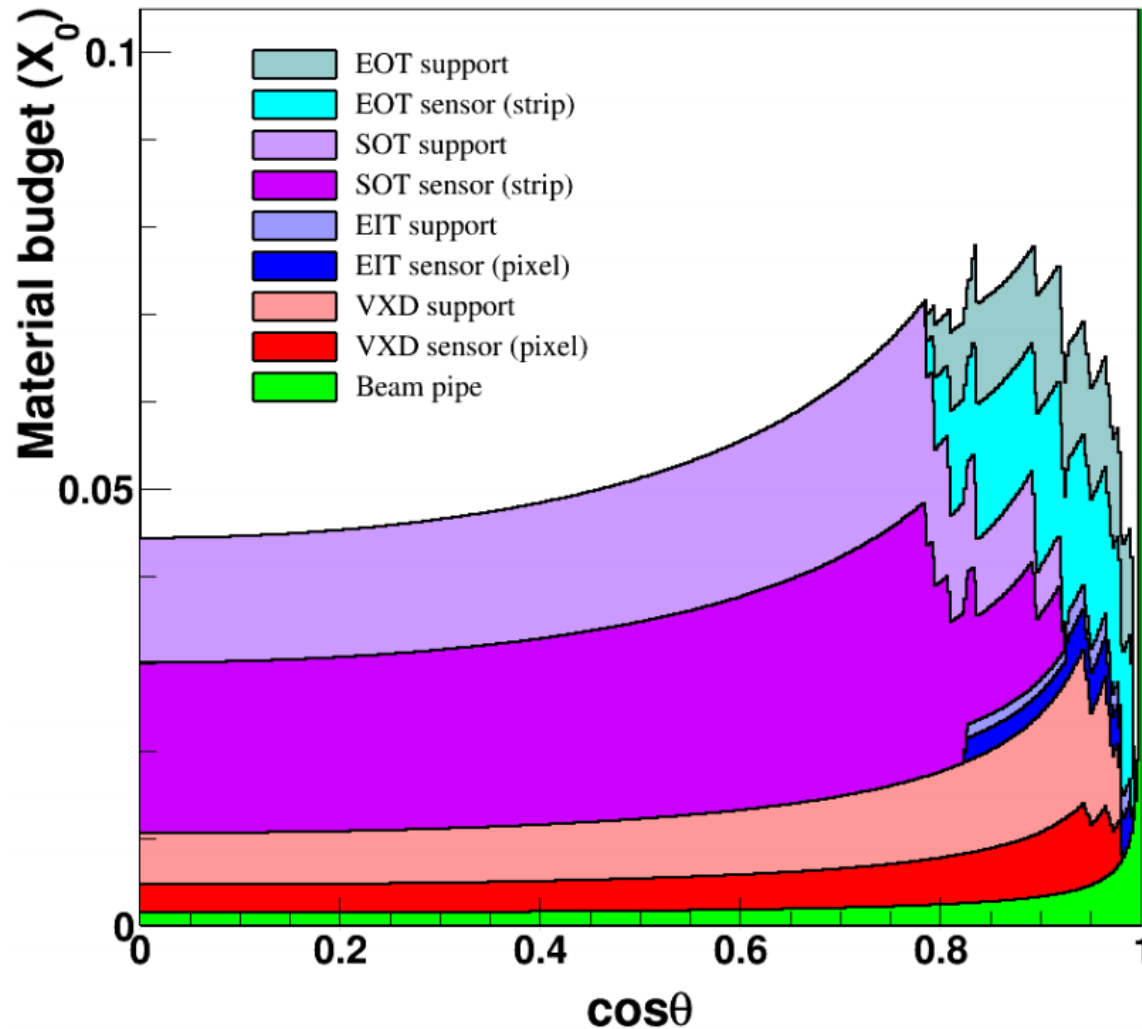
SiD-like, half of support layers, considering for two single-side layers combined as one double-side layer.

EIT (pixel)	silicon	Carbon fiber	Rohacell50D	peek	Total support
Thickness(mm)	0.2+0.0048	0.16	1.8	0.2	2.1648

EOT (strip)	silicon	peek	Carbon fiber	Rohacell 50D	epoxy	Carbon fiber	silicon	Total support
Thickness(mm)	0.15	0.2	0.16	1.8	0.175	0.16	0.15+0.0048	2.4998

Material Budget of FST

■ From ~4.5% of X_0 to ~8.1% ($\cos\theta < 0.99$)



Simulation and Reconstruction Tools

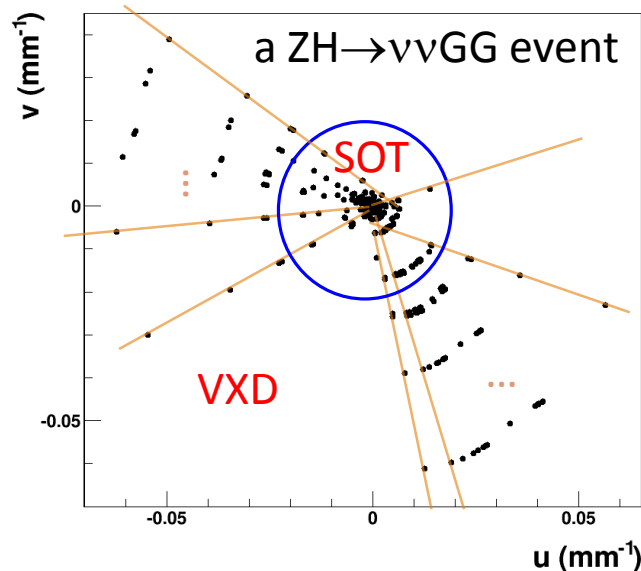
■ **MokkaC**—a developed **Mokka** version @CepC

➤ <http://cepcgit.ihep.ac.cn/cepcsoft/MokkaC>

■ Tracking and fit

➤ **ConformalTracking**

✓ used as the main track pattern recognition algorithm at **CLIC**, and **FCC-ee** are also performing



✓ Conformal space:

$$u = \frac{x}{x^2 + y^2}, \quad v = \frac{y}{x^2 + y^2}$$

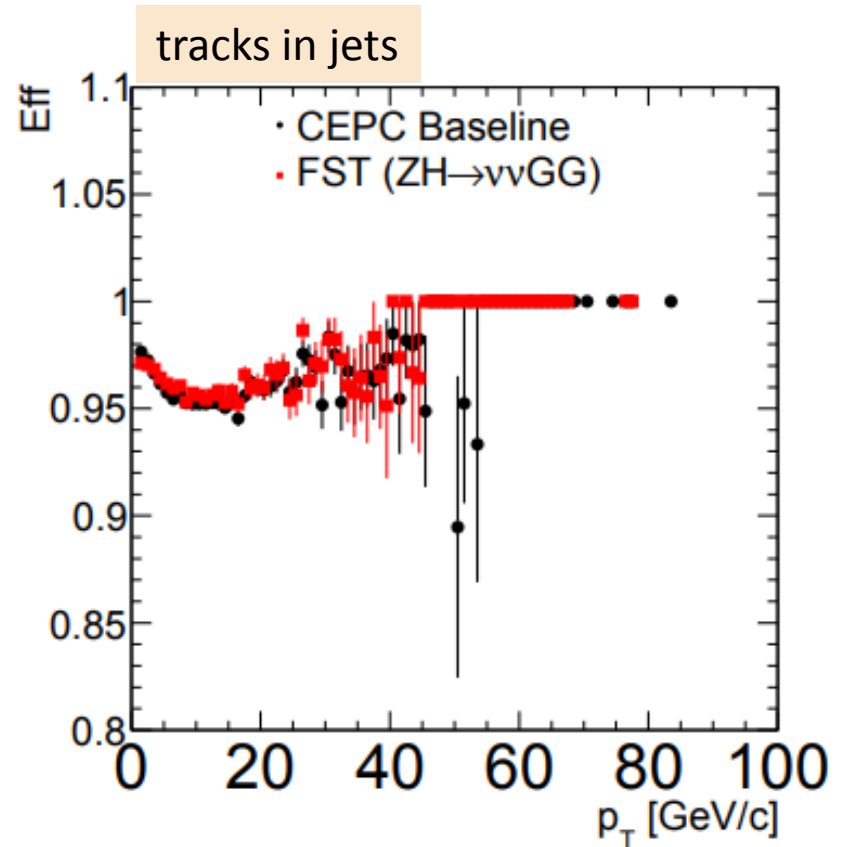
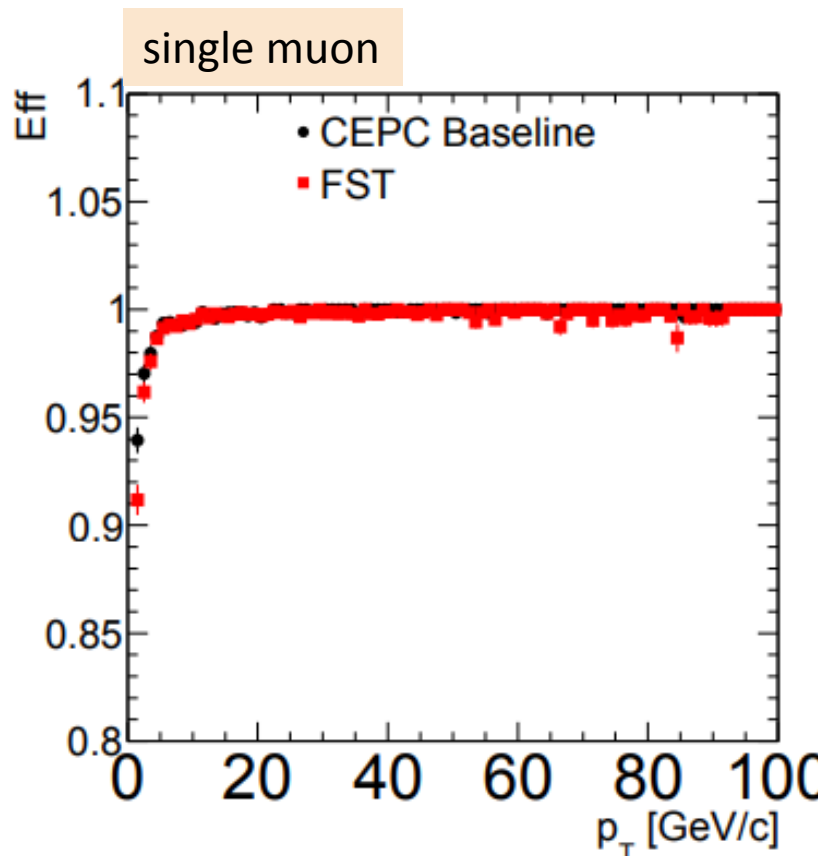
✓ In conformal space, a track in magnetic field is a straight line

✓ Track finding becomes straight line searching by pattern recognition (cellular automaton)

✓ Implemented into CepC software, and ongoing

Tracking(?) Efficiency of FST

- ϵ = tracks matched with MC truth (>50% hits) / stable tracks (no decay in tracker, $\sin\theta > 0.18$)
 - relative to stable tracks and matching algorithm, tracks in jets are influenced more

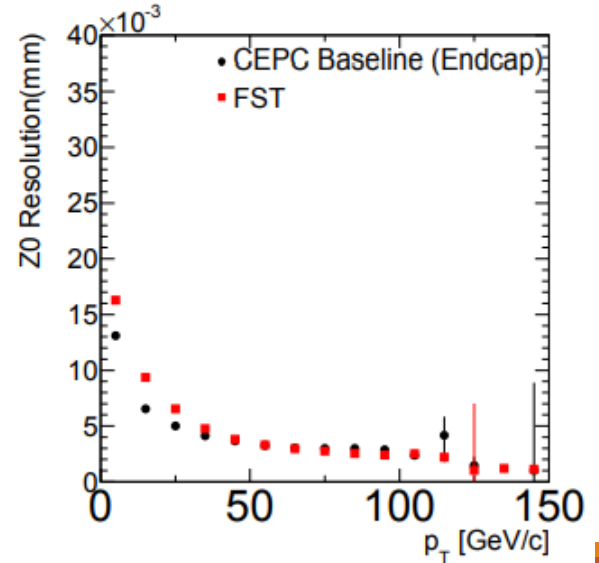
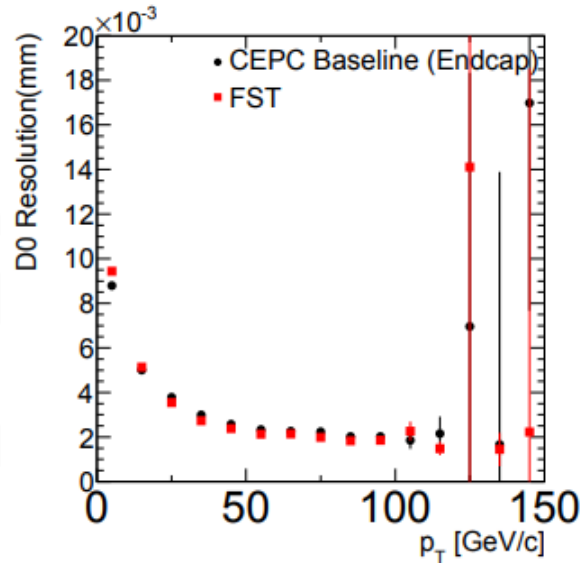
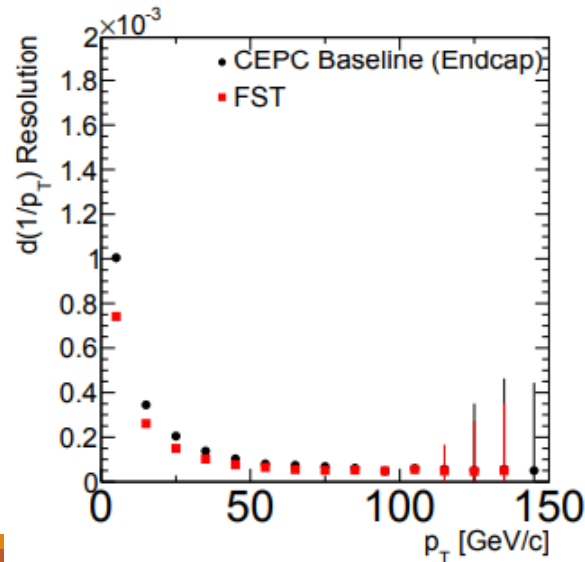
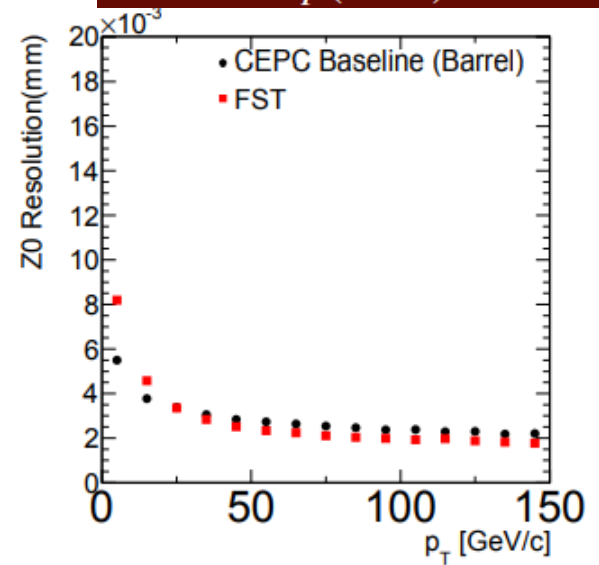
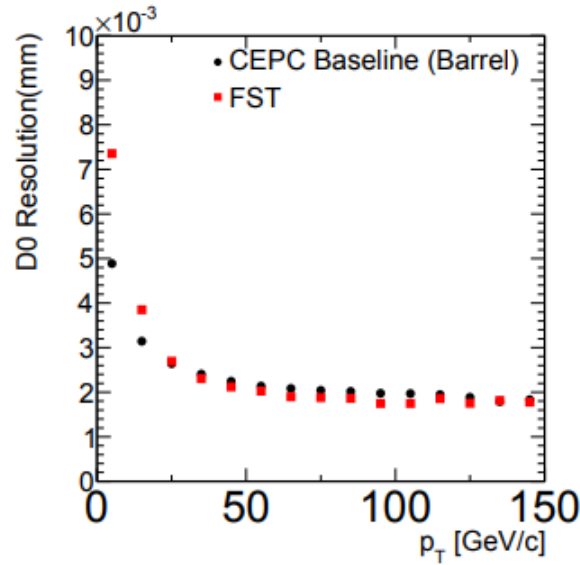
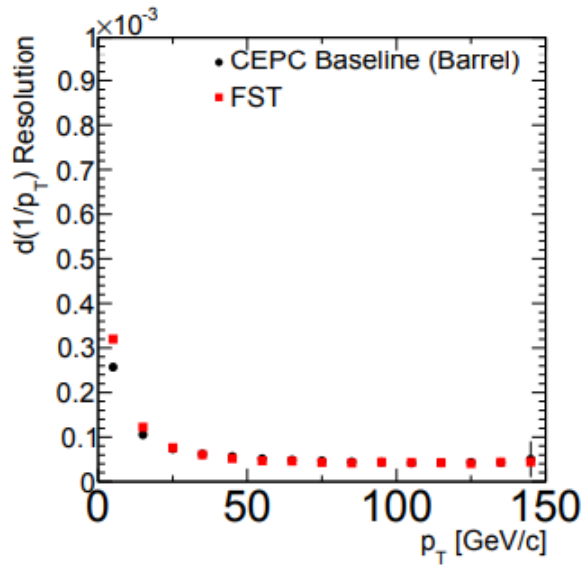


Resolution of FST (Single Muon)

Gang's talk

$$\Delta(1/P_T) = 2 \times 10^{-5} \oplus \frac{0.001}{P(\text{GeV})\sin^{3/2}\theta}$$

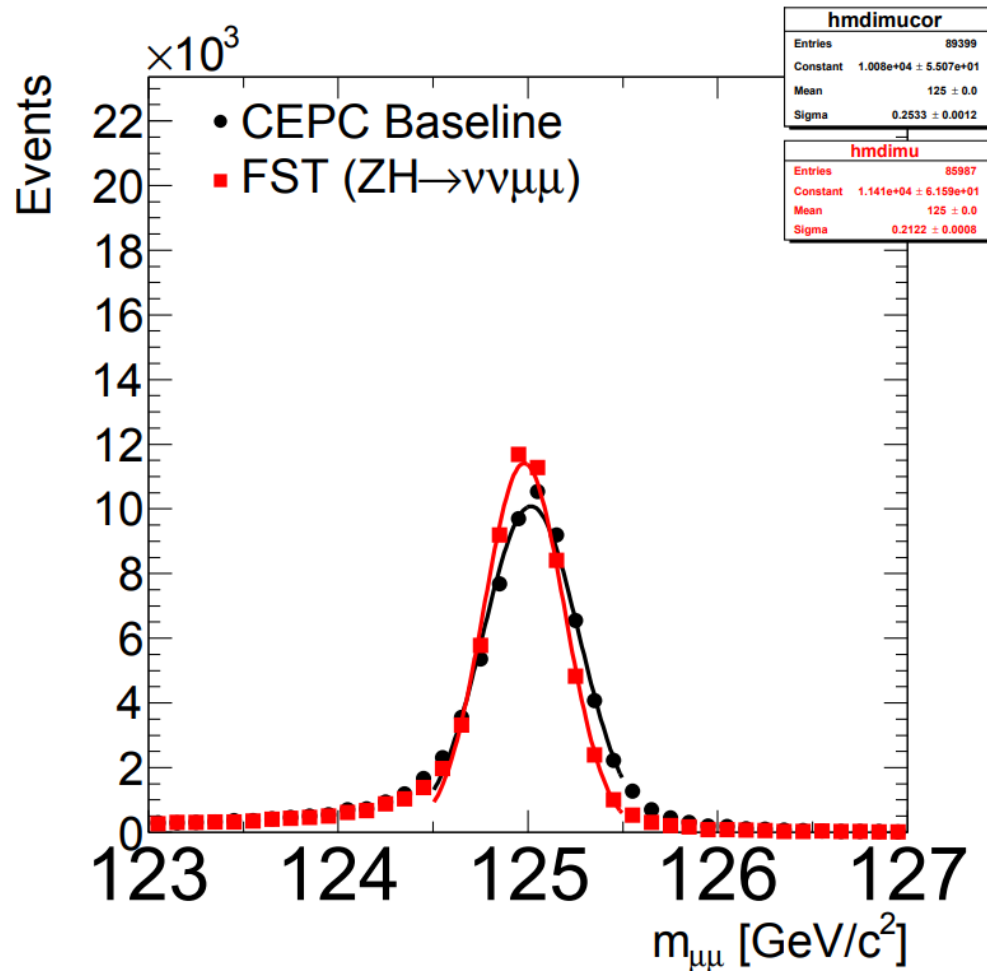
$$\sigma_{r\phi} = 5 \oplus \frac{10}{p(\text{GeV})\sin^{3/2}\theta} (\mu\text{m})$$



Mass Resolution ($H \rightarrow \mu\mu$)

■ Comparing to the baseline detector without PFA

➤ 0.21 GeV by FST



Future plan

Area/m ²	pixel (B+E)	strip (B+E)	total
baseline	0.37 + 0.13	111.76 + 1.69	113.95
FST	0.46 + 0.13	225.62 + 41.96	268.17
FST/baseline	1.18	2.36	2.35
FST Channels(10 ⁶)	~900	~60	~1000

- Issues in algorithm and software
- Optimize layouts
 - silicon thickness
 - support structure
- Electronics in simulation
- If necessary, balance cost and performance
- Study on physical performance, implement into PFA

Conclusion

- The concepts of **full silicon tracker** have been implemented and seem working.
- Two options have been considered, one for expensive and higher performance, close to the baseline detector, another for cheap
 - Performance for more options can be estimated as between them.
- Based on comparison with the baseline detector, it is expectable that the full silicon tracker can provide close performance for those particles with long life.
- More optimization and study are in plan.

Thank you for your attention!